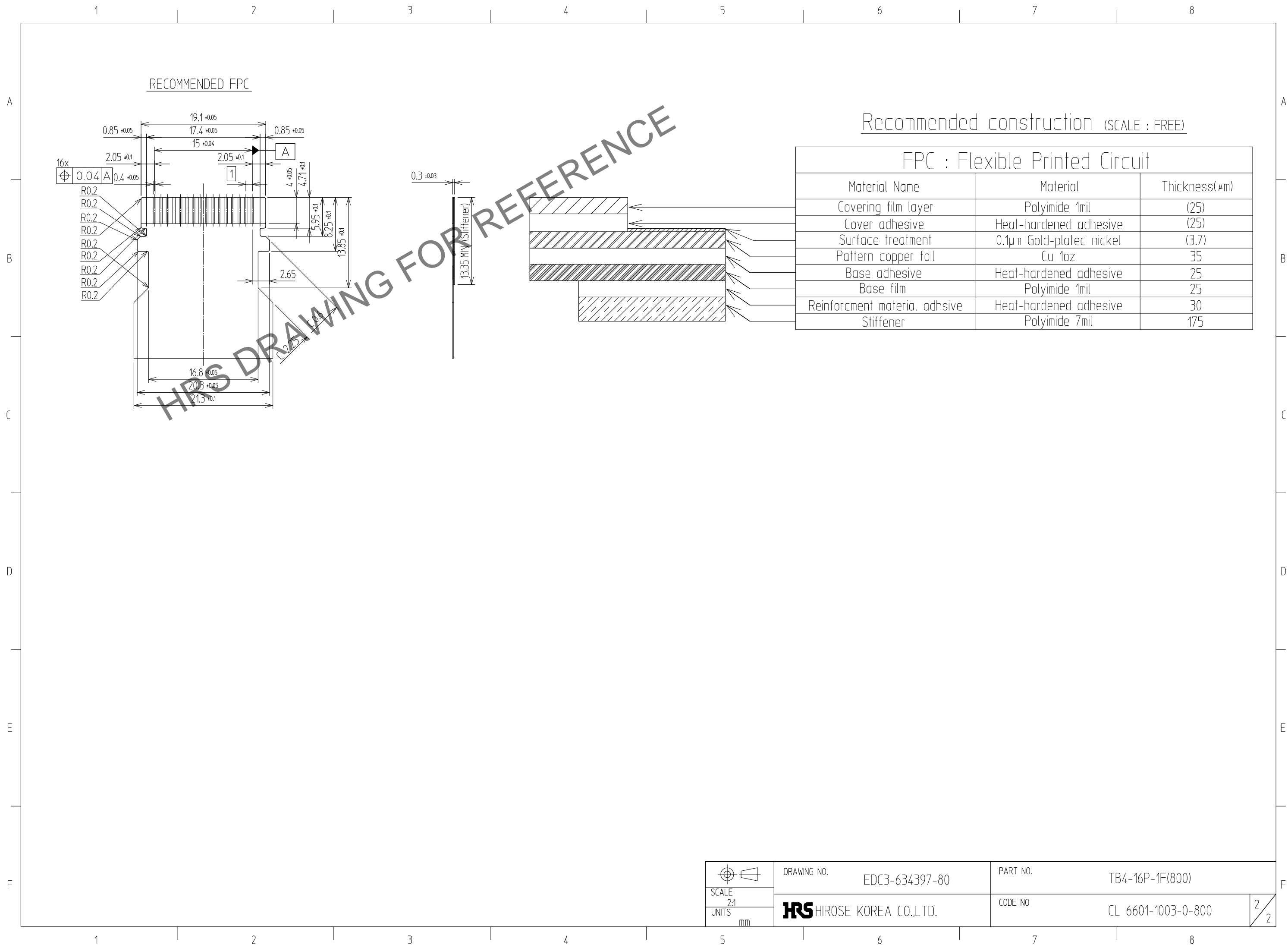


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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window



Recommended construction (SCALE : FREE)

FPC : Flexible Printed Circuit		
Material Name	Material	Thickness(μm)
Covering film layer	Polyimide 1mil	(25)
Cover adhesive	Heat-hardened adhesive	(25)
Surface treatment	0.1μm Gold-plated nickel	(3.7)
Pattern copper foil	Cu 1oz	35
Base adhesive	Heat-hardened adhesive	25
Base film	Polyimide 1mil	25
Reinforcement material adhesive	Heat-hardened adhesive	30
Stiffener	Polyimide 7mil	175

 SCALE 2:1 UNITS mm	DRAWING NO.	EDC3-634397-80	PART NO.	TB4-16P-1F(800)
	HIROSE KOREA CO.,LTD.		CODE NO.	CL 6601-1003-0-800